MOSFET – Power, Single, N-Channel, Logic Level, SO-8FL

30 V, 0.67 mΩ, 370 A

NTMFS4C020N

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- Optimized for 4.5 Gate Drive
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

	(1) = 20 (
Paran	neter		Symbol	Value	Unit
Drain-to-Source Voltag	е		V _{DSS}	30	V
Gate-to-Source Voltage	to-Source Voltage		V _{GS}	±20	V
Continuous Drain Current $R_{\theta JC}$ (Notes 1, 3)	Steady	$T_{C} = 25^{\circ}C$	۱ _D	370	A
Power Dissipation $R_{\theta JC}$ (Notes 1, 3)	State	$T_C = 25^{\circ}C$	P _D	161	W
$\begin{array}{l} \mbox{Continuous Drain Current } R_{\theta JA} \ (\mbox{Notes 1, 2, } 3) \end{array}$	Steady State	T _A = 25°C	Ι _D	57	A
Power Dissipation $R_{\theta JA}$ (Notes 1, 2, 3)	01010	$T_A = 25^{\circ}C$	P _D	3.84	W
Pulsed Drain Current	T _A = 25	°C, t _p = 10 μs	I _{DM}	900	А
Operating Junction and	Storage T	emperature	T _J , T _{stg}	–55 to 150	°C
Source Current (Body D	iode)		۱ _S	110	А
Single Pulse Drain-to-S Energy (I _{L(pk)} = 35 A)	-Source Avalanche		E _{AS}	862	mJ
Lead Temperature for So (1/8" from case for 10 s)		urposes	ΤL	260	°C

MAXIMUM RATINGS (T, I = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS (Note 1)

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	0.93	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	39	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

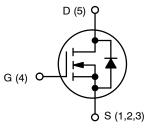
2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.



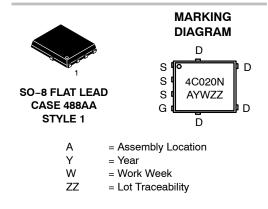
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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
	$0.67~\mathrm{m}\Omega\ensuremath{@}10~\mathrm{V}$	
30 V	0.78 mΩ @ 6.5 V	370 A
	0.95 mΩ @ 4.5 V	



N-CHANNEL MOSFET



ORDERING INFORMATION

Device	Package	Shipping [†]
NTMFS4C020NT1G	SO–8 FL (Pb–Free)	1500 / Tape & Reel
NTMFS4C020NT3G	SO–8 FL (Pb–Free)	5000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

^{3.} Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_D = 250 μ A		30			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				16.3		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = 24 V	T _J = 25 °C			1	
		V _{DS} = 24 V	T _J = 125°C			100	μA
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_{GS} = 20 V$				100	nA

ON CHARACTERISTICS (Note 4)

Gate Threshold Voltage	V _{GS(TH)}	$V_{GS}=V_{DS},\ I_{D}=250\ \mu A$		1.3		2.2	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				5.8		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 30 A		0.56	0.67	
		V _{GS} = 6.5 V	I _D = 30 A		0.56	0.78	mΩ
		V _{GS} = 4.5 V	I _D = 30 A		0.76	0.95	
Forward Transconductance	9 _{FS}	V _{DS} = 3 V, I _D = 30 A			183		S
Gate Resistance	R _G	T _A = 25 °C			1.0	2.5	Ω

CHARGES AND CAPACITANCES

Input Capacitance	C _{ISS}		10144	15250	
Output Capacitance	C _{OSS}	V_{GS} = 0 V, f = 1 MHz, V_{DS} = 15 V	5073	7610	pF
Reverse Transfer Capacitance	C _{RSS}		148	350	
Total Gate Charge	Q _{G(TOT)}		63	105	
Threshold Gate Charge	Q _{G(TH)}		18	36	-0
Gate-to-Source Charge	Q _{GS}	V _{GS} = 4.5 V, V _{DS} = 15 V; I _D = 30 A	29	58	nC
Gate-to-Drain Charge	Q _{GD}		13	26	
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 10 V, V_{DS} = 15 V, I _D = 30 A	139	230	nC

SWITCHING CHARACTERISTICS (Note 5)

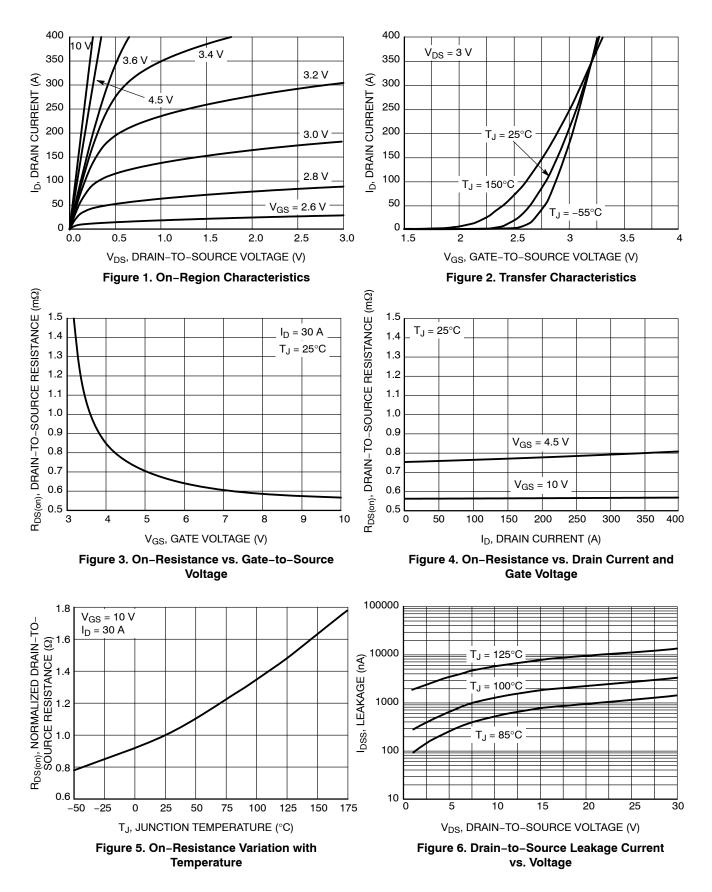
Turn-On Delay Time	t _{d(ON)}		29	
Rise Time	t _r	V _{GS} = 4.5 V, V _{DS} = 15 V, I _D = 15 A,	68	
Turn-Off Delay Time	t _{d(OFF)}	R _G = 3.0 Ω	53	ns
Fall Time	t _f		36	

DRAIN-SOURCE DIODE CHARACTERISTICS

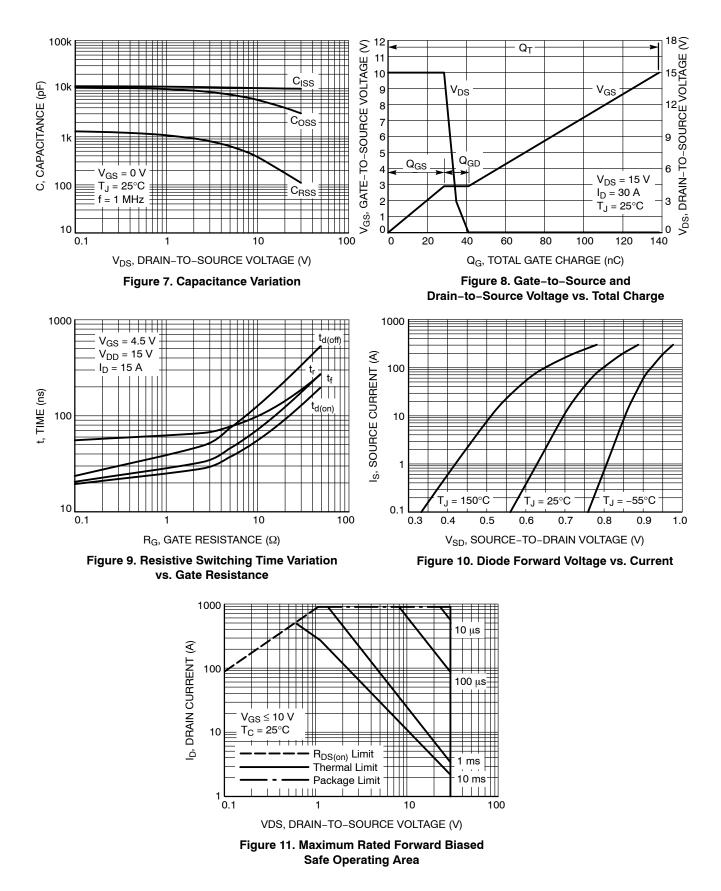
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V, I _S = 10 A	$T_J = 25^{\circ}C$	0.73	1.1	N
		I _S = 10 A	T _J = 125°C	0.55		v
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dI _S /dt = 100 A/µs, I _S = 30 A		87		
Charge Time	ta			43		ns
Discharge Time	t _b			44		
Reverse Recovery Charge	Q _{RR}			147		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width $\leq 300 \ \mu$ s, duty cycle $\leq 2\%$. 5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



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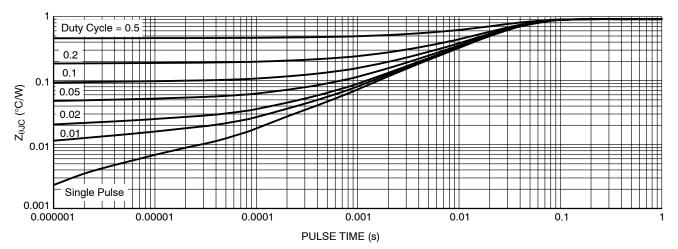


Figure 12. Thermal Resistance

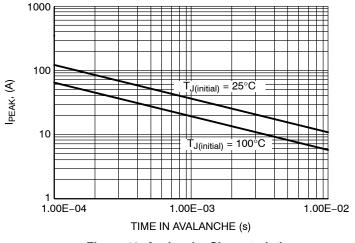
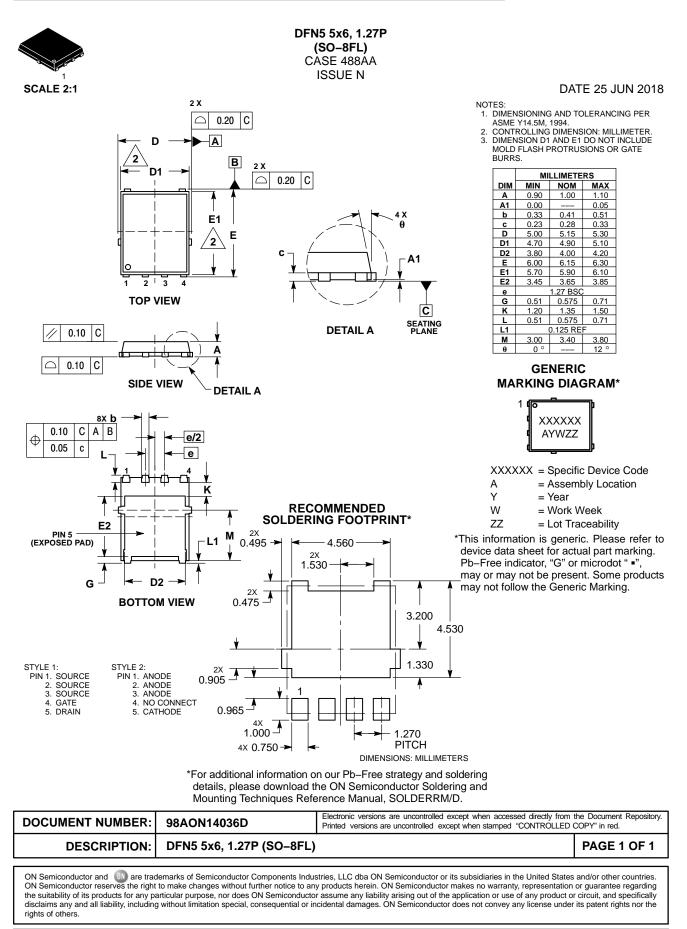


Figure 13. Avalanche Characteristics





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